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July 28, 1999

VIA EXPRESS MAIL
TB700826588US

BOX PATENT APPLICATION

Assistant Commissioner
for Patents

Washington, D.C. 20231

Re: Balzers Aktiengesellschaft
New Divisional Patent Application
For: INFORMATION CARRIER AND METHOD
FOR PRODUCING THE SAME
Inventor: KUGLER
Our Ref. H60-056 DIV

Sir:

The above-identified patent application is transmitted herewith for filing.

Enclosed are:

1. Copy of Specification, Claims and Abstract (48 pages), as originally filed in parent application;
2. Copy of Four (4) Sheets of Drawings containing Figs. 1-5, as filed in parent application;
3. Copy of Declaration and Power of Attorney, as filed in parent application;
4. Check in the amount of \$1,528.00; and
5. Preliminary Amendment.

The present application is owned by Balzers Aktiengesellschaft by an Assignment recorded in the parent application no. 08/674,019.

Assistant Commissioner
for Patents
July 28, 1999
Page 2

Fees Calculation:

Basic Fee:		\$ 760.00
Total No. of Claims Filed:	54 (-20) = 34 x 18.00	612.00
Total No. of Independent Claims Filed:	5 (-3) = 2 x 78.00	156.00
Multiple Dependent Claims:		00.00
Assignment:		00.00
	Total Fee	\$ <u>1,528.00</u>

Kindly acknowledge receipt of the above items by having your mail room stamp and return the enclosed postcard.

The Commissioner is hereby authorized to charge any fee under 37 CFR 1.16 and 1.17 which may be required during the entire pendency of the application to Deposit Account No. 14-1431.

This application is a DIVISIONAL APPLICATION of U.S. Serial No. 08/674,019, filed July 1, 1996, which has been allowed. Priority is still claimed under 35 U.S.C. § 119 based on Swiss Patent Application No. 2495/95, filed September 1, 1995, the certified copy of which has been filed in a prior parent application No. 08/593,664.

Dated: July 28, 1999

Respectfully submitted,



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Enclosures

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to the Box Non-Fee Amendment, Assistant Commissioner for Patents, Washington, D.C. 20231 on July 28, 1999:

By: Celestine Boomer

Dated: July 28, 1999

Patent
Atty. Docket:H60-056 DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Kugler, E.
Serial No. of Parent : 08/674,019
Filing Date : July 23, 1999
For : INFORMATION CARRIER,
METHOD FOR PRODUCING SAME
Examiner of Parent : Evans, E.
Group Art Unit of Parent : 1774

Box Non-Fee Amendment
Assistant Commissioner for Patents
Washington, D.C. 20231

PRELIMINARY AMENDMENT IN DIVISIONAL APPLICATION

Sir:

In advance of the prosecution in the above-identified application, please amend the same as follows:

IN THE SPECIFICATION:

Page 1, cancel lines 2 and 3 and substitute the following:

--CROSS-REFERENCE TO RELATED APPLICATIONS

The present application is a Divisional of application no. 08/674,019 which is now U.S. Patent _____, which was a Continuation-In-Part of application no. 08/593,664 filed on January 29, 1996, which is incorporated here by reference, and which is now abandoned. U.S. application no. 08/300,865, now abandoned, is also incorporated here by reference.--

Page 6, line 16, change "0,6" to --0.6--;

Line 17, change "0,2" to --0.2--;

Lines 26 and 27, change "1,2" to --1.2--;

Line 28, change "1,6" to --1.6--;

Page 9, between lines 8 and 9, add the heading **--Description of the Preferred Embodiments--**;

Page 11, line 24, change "1,2" to --1.2-- (Both occurrences);

Page 12, line 1, change "1,6" to --1.6--;

Line 7, change "0,8" to --0.8--, change "0,05" to --0.05-- and change "0,1" to --0.1--;

Line 9, change "0,52" to --0.52--, change "0,1" to --0.1--, and change "0,2" to --0.2--;

Line 10, change "0,8" to --0.8--, change "0,05" to --0.05--, and change "0,1" to --0.1--;

Line 12, change "0,445:0,262" to --0.445:0.262--, and

change "0,775:0,078" to --0.775:0.078--;

Line 16, change "0,445:0,249" to --0.445:0.249--, and
change "0,775:0,118" to --0.775:0.118--;

Line 20, change "0,078:0,249" to --0.078:0.249--, and
change "0,262:0,118" to --0.262:0.118--;

Page 13, line 5, change "0,704" to --0.704--, change "0,087"
to --0.087--, and change "0,131" to --0.131--;

Line 11, change "0,494" to --0.494--, change "0,238" to
--0.238--, and change "0,226" to --0.226--;

Line 12, change "0,527:0,401" to --0.527:0.401--, and
change "0,858:0,099" to --0.858:0.099--;

Line 16, change "0,527:0,044" to --0.527:0.044--, and
change "0,858:0,009" to --0.858:0.009--;

Line 20, change "0,099:0,044" to --0.099:0.044--, and
change "0,401:0,009" to --0.401:0.009--;

Page 14, line 3, change "0,78" to --0.78--, and change
"0,11" to --0.11--;

Line 8, change "0,586" to --0.586--, and change "0,364"
to --0.364--;

Page 15, line 2, change "0,2" to --0.2--;

Line 11, change "0,6" to --0.6--;

Line 12, change "0,2" to --0.2--;

Page 18, line 30, change " $0,4 \leq m \leq 1,2$ " to -- $0.4 \leq m \leq 1.2$ --
-, and change " $2,4 \leq m \leq 3,2$ " to -- $2.4 \leq m \leq 3.2$ --;

Page 19, line 1, change " $4,4 \leq m \leq 5,2$ " to -- $4.4 \leq m \leq 5.2$ --;

Page 24, line 15, change "2,5" to --2.5--, and change "2,7" to --2.7--;

Page 29, line 2, change "0,5Hz" to --0.5Hz--;

Page 30, line 6, change " $0,2 \leq R_2 \leq 0,4$ " to -- $0.2 \leq R_2 \leq 0.4$ --;

Line 7, change " $0.2 \leq (R_1 \cdot T_2^2) \leq 0,4$ " to -- $0,2 \leq (R_1 \cdot T_2^2) \leq 0.4$ --;

Line 8, change "2,59" to --2.59--;

Line 9, change "3,2" to --3.2--;

Line 12, change "1,5" to --1.5--;

Line 13, change "0,5" to --0.5--;

Line 14, change "0,1" to --0.1--;

Page 31, line 15 change "2,5" to --2.5--, and change "0,5" to --0.5--;

Line 26, change "stationarily" to --stationary--;

Page 33, line 7, change "3,97" to --3.97--, change "2,81" to --2.81--, change "3,31" to --3.31--, and change "0,06" to --0.06--;

Line 8, change "32,2%" to --32.2%--;

Page 34, line 19, change "4,6" to --4.6--, change "2,8" to --2.8--, and change "3,2" to --3.2--;

Line 22, change "3,0" to --3.0--, and change "2,7" to --2.7--;

Line 23, change "0,5" to --0.5--, and change "0,1" to --0.1--.

IN THE ABSTRACT:

As a last page of the Specification, please add the attached
ABSTRACT OF THE DISCLOSURE.

IN THE CLAIMS:

Cancel Claims 1-53.

Please add the following claims:

76. A method for producing an information carrier comprising at least two solid material interfaces at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interface, further comprising at least one intermediate layer between said two solid material interfaces, said layer transmitting said radiation, said information being readable from a least one of said solid material interfaces by means of radiation of predetermined wavelength, comprising the step of depositing in said intermediate layer at least one layer at least predominantly consisting of at least one of Si_xC_y and of Si_vN_w by means of a reactive vacuum coating process, comprising the step of freeing Si from a solid body into a process atmosphere with a reactive gas containing at least one of C and N.

77. A method for producing an information carrier comprising at least two solid material interfaces at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interface, further comprising at least one intermediate layer between said two solid material interfaces, said layer transmitting said radiation, said information being readable from a least one of said solid material interfaces by means of radiation of predetermined wavelength, comprising the step of depositing in said intermediate layer at least one layer at least predominantly consisting of at least one of $\text{Si}_x\text{C}_y\text{H}_z$ and $\text{Si}_v\text{N}_w\text{H}_u$ by means of a reactive vacuum coating process in a process atmosphere, an optimum of transmission of said layer and of a refractive index of the material of said layer being achieved by adjusting the concentration of a gas in the process atmosphere, which gas comprises at least two of C, N and H.

Claim 54, line 1, change "53" to --77--;

Claim 55, line 1, change "one of the claims 52 to 54" to --claim 76 or 77--;

Claim 56, line 1, change "one of the claims 52 to 54" to --claim 76 or 77--;

Claim 59, line 1, change "one of the claims 55 to 57" to --claim 76 or 77--;

Claim 61, line 1, change "one of the claims 52 to 57" to
--claim 76 or 77--;

Claim 62, line 1, change "one of the claims 52 to 54" to
--claim 76 or 77--;

Claim 65, line 1, change "one of the claims 52 to 54" to
--claim 76 or 77--;

Claim 66, line 1, change "one of the claims 52 to 54" to
--claim 76 or 77--;

Cancel Claim 67 and substitute therefore the following
claim:

78. An apparatus for producing an information carrier comprising at least two solid material interfaces at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interface, further comprising at least one intermediate layer between said two solid material interfaces, said layer transmitting said radiation, said information being readable from a least one of said solid material interfaces by means of radiation of predetermined wavelength, said intermediate layer comprising a layer at least predominantly of one of Si_xC_y , $\text{Si}_x\text{C}_y\text{H}_z$, Si_vN_w , $\text{Si}_v\text{N}_w\text{H}_u$, comprising a vacuum recipient with a workpiece carrier electrode therein and a solid body material source, which frees silicon into said vacuum recipient, and

further comprising a gas inlet which is connected to a gas reservoir with a gas containing at least one of C and N.

Claim 68, line 1, change "67" to --78--;

Claim 69, line 1, change "one of the claims 67 or 68" to --claim 78--;

Claim 71, line 1, change "one of the claims 67 or 68" to --claim 78--;

Claim 72, line 1, change "one of the claims 67 or 68" to --claim 78--;

Claim 73, line 1, change "one of the claims 67 or 68" to --claim 78--;

Cancel Claims 74 and 75, and add the following claims:

79. An apparatus according to claim 78, including a target which consists of a negatively or positively doped silicon.

80. An apparatus according to claim 79, wherein the target is doped with at least one of Boron and Phosphor.

Add the following claims:

81. A method according to claim 76 or 77, wherein the method includes applying a silver layer between one of the solid material interfaces and the intermediate layer.

82. A method according to claim 76 or 77, including depositing the intermediate layer to have a layer system with an optical thickness which, at least in a first approximation, is $m \cdot \lambda_0 / 4$, wherein m is an integer of at least unity and is uneven and wherein λ_0 designates the wavelength of said radiation which is transmitted through said at least one layer and wherein, depending from said m being an integer, m may be reduced by an amount of up to 0.6 or increased by an amount of up to 0.2.

83. A method according to claim 82, including depositing the intermediate layer so that the electromagnetic radiation for either applying or reading information has a wavelength within the band of

$$400\text{nm} \leq \lambda_s \leq 800\text{nm}.$$

84. A method according to claim 82, wherein at least one of the solid material interfaces is made to have a reflection of from about 20% to about 40% for a selected wavelength of said radiation.

85. A method according to claim 82, wherein said intermediate layer is deposited to have an index of refraction of greater than or equal to 2.59 and less than or equal to 4.6 and an extinction coefficient of less than or equal to 3.0.

86. A method according to claim 82, wherein x is greater than or equal to y .

87. A method according to claim 82, wherein v is greater than or equal to w .

88. A method according to claim 82, wherein x is less than or equal to 0.8, y is greater than or equal to 0.05 and z is greater than or equal to 0.1.

89. A method for producing an information carrier comprising at least two solid material interfaces at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interface, further comprising at least one intermediate layer between said two solid material interfaces, said layer transmitting said radiation, said information being readable from a least one of said solid material interfaces by means of radiation of predetermined wavelength, comprising the step of depositing a silver layer between one of the solid material interfaces and the intermediate layer.

90. An information carrier, comprising at least two solid material interfaces at which information is or may be applied and

whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces, further comprising at least one intermediate layer between said two solid material interfaces, which layer transmitting said radiation, said information being readable from at least one of said solid material interfaces by means of radiation of predetermined wavelength, wherein said intermediate layer comprises a dielectric layer system with at least one layer and a further layer comprising a silver layer between one of the solid material interfaces and the intermediate layer.

REMARKS:

Claims 54-66, 68-73 and 76-90 are in the case and presented for consideration.

The priority document Swiss 2495/95 was filed in the parent application, serial no. 08/593,664 on January 29, 1996.

Accordingly, the application and claims are believed to be in condition for allowance, and favorable action is respectfully requested.

If any issues remain which may be resolved by telephonic communication, the Examiner is respectfully invited to contact

the undersigned at the number below, if such will advance the application to allowance.

Dated: July 28, 1999

Respectfully submitted,



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ABSTRACT OF THE DISCLOSURE

A method and apparatus for producing an information carrier which has at least two solid material interfaces at which information is, or may be applied and where the information is stored by local modulation of at least one characteristic of the solid material. Reflection of electromagnetic radiation at the interface depends on this characteristic. The method and apparatus applies at least one intermediate layer between the two solid material interfaces. The intermediate layer transmits the radiation and is at least predominantly made of either Si_xC_y or Si_yN_w , or both.

1654-101 A
08/674019

Technical field

As solid material interface we understand the transition area where one material surface is intimately contacted by a second material surface.

The present invention is further generally directed to a method for producing a layer, which at least predominantly consists of Si_xC_y or of $\text{Si}_x\text{C}_y\text{H}_z$ or of Si_vN_w or of $\text{Si}_v\text{N}_w\text{H}_u$ by means of a reactive vacuum coating process, and further is directed to a vacuum coating apparatus which is specifically suited for performing the said method of producing the said layer. The method for producing the said layer is particularly suited for producing at least one layer at the said intermediate layer of the information carrier.

In Compact News 1995, "Optical Disc Manufacturing Equipment", so-called high density CDs of different basic principles are

shown in general view.

Therefrom, so-called MMCD or "single sided dual layer high density CD" or "hdCD" are known as optical information carrier in the shape of CDs, at which the information density is considerably improved. This is achieved by providing two solid material interfaces, whereat information is stored on a carrier substrate. The solid material interfaces are separated by means of an intermediate layer. The information at the solid material interfaces is applied by local modulation of a surface pattern of intrusions at one of the material surfaces forming the interface. Reading information is realized by means of a beam of electromagnetic radiation in the form of laser light of 635nm or 650nm wavelength or especially of 450nm. The intermediate layer between the information carrying solid material interfaces is practically transmittant to 100% at those wavelengths, so that a part of the impinging beam energy is reflected at the one information carrying solid material interface and a second part at the second.

Further, from the article mentioned above, so-called hybrid MMCD are known, whereat the information provided at respective ones of two information carrying solid material interfaces is selectively read by means of radiation at different wavelengths, namely, on the one hand, by means of a laser beam with a wavelength of light of 635nm and, on the other hand, with a laser beam with a wavelength of light at 785nm.

As was mentioned above, the present invention is most generically dealing with such information carriers, method for producing same and apparatus therefor, whereby it must be pointed out that, under this generic aspect, information at the said solid material interfaces may be applied by local

modulation of surface structure, as at the well-known optical storage carriers, or may be provided or applied at in the sense of magneto-optical storage as is known from the US-5 158 834. Thus, the present invention, under its most generic aspect, is not limited to information carriers which are already provided with stored information, as e.g. stored by mechanical forming process from a master as known from optical storage disks, but the present invention is also directed to information carriers which are yet empty of information and onto which the information is to be loaded or written.

From the article mentioned above, still further techniques are known for improving information density of CDs. According to one approach, which is known as SD, "super density", two substrates each with one information carrying solid material interface at one side are laid one on the other in back-to-back relation and are linked. The information is read by means of a 650nm laser beam from either side of the linked carriers. By the fact that, according to one improvement of the SD resulting into so-called "dual layer SD", there is provided, between the information carrying interfaces, an intermediate layer which is transmittant for the light radiation at the wavelength predetermined for reading, the total information becomes readable from one side of the disk. The present invention is also directed to an information carrier of this kind. Thus, information carriers which are the subject of the present invention, may be generically referred to as

"bi- or multiple-reflecting" carriers.

It is common to all such information carriers that electromagnetic radiation for writing and/or reading information to or from the two solid material interfaces is, to a first

part, reflected from a first solid material interface, the remaining part being transmitted through the intermediate layer and is reflected as impinging on the second solid material interface. It is customary that the intermediate layer comprises at least two layers, one of which being optically effective, especially contributing to reflection, the other of which primarily acting as a spacer.

Objects of the invention

The requirement which shall be fulfilled by such an information carrier is primarily that information contained at the said at least two solid material interfaces shall be readable (or writable) substantially equally. Thus, it is an object of the present invention to provide an information carrier of the mentioned type, whereat the said optically effective layer fulfils at least one of the following requirements:

- low cost manufacturing;
- The reflection at one of the intermediate layer surfaces and a further material concomitantly forming one of the said solid material interfaces shall be as high as possible, but simultaneously also transmission through the said intermediate layer for radiation of predetermined wavelength shall be maximized, i.e. absorption shall be negligible. Thereby, as a further material, a material shall be applicable which is usually used as either carrier substrate material or as spacer layer material or as covering layer material.
- The layer shall be applicable at temperatures which are so low that known plastic substrate materials may be layer-coated.

- In the UV spectral range the layer shall have a high transmission, too, so that, if a UV hardenable lacquer is applied e.g. as an interface co-forming material or as a material of a spacer layer, UV radiation may be applied through the optically effective layer, so as to harden such a lacquer through the optically effective layer.
- The optically effective layer shall further well adhere to common plastic substrate materials as well as to common interface co-forming materials as e.g. to the said lacquer.
- The optically effective layer shall further be suited for applications of radiation in the wavelength band of 400nm to 800nm, but especially for radiation with a wavelength in the band of 633nm to 650nm.

These objects are at least in part achieved by an information carrier which comprises at least two solid material interfaces, at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces and which further comprises at least one intermediate layer between the two solid material interfaces, which intermediate layer transmits the radiation and which intermediate layer further comprises a layer which is at least predominantly of Si_xC_y or of Si_vN_w .

Further, at least a part of the objects mentioned above are resolved by an information carrier which comprises at least two solid material interfaces, at which information is or may be applied and whereat the information is stored by local

modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces, and which further comprises at least one intermediate layer between the two solid material interfaces, which layer transmits the radiation, and wherein further the information which is readable from at least one of the solid material interfaces is readable by means of radiation of predetermined wavelength, whereby the intermediate layer comprises a dielectric layer system with at least one layer, wherein the dielectric layer system has an optical thickness D which, at least in a first approximation, is $m \cdot \lambda_0/4$, wherein m is integer and at least unity and is odd and wherein λ_0 designates the wavelength of the radiation which is transmitted through the at least one dielectric layer of the dielectric layer system.

Thereby, m may be selected smaller up to 0,6 to its integer value or up to 0,2 larger. Thus, by selecting reduced value of m , and for desired reflection characteristics, a dielectric layer system of significantly reduced thickness may be used, thus significantly improving economic production.

Thereby, preferred dielectric layer materials are Si_xC_y , $\text{Si}_x\text{C}_y\text{H}_z$, Si_vN_w or $\text{Si}_v\text{N}_w\text{H}_u$, but also ZrN or even HfN and TiN may be applicable.

When Si_xC_y , $\text{Si}_x\text{C}_y\text{H}_z$, Si_vN_w or $\text{Si}_v\text{N}_w\text{H}_u$ materials are used as layer material, it has been found that x/y and respectively v/w should be larger than unity, that preferably $x/y \geq 1,2$ and respectively $v/w \geq 1,2$ and, even better, $x/y \geq 2$, respectively $v/w \geq 1,6$.

Thereby, the intermediate layer at the inventive information carrier allows, due to the reflection controlling character-

istics of its material, namely due to refractive index n and to its transmission characteristics (low absorption), to provide even more than two, i.e. three or more information carrying solid material interfaces and to read information therefrom from one side and preferably with one radiation wavelength.

It is a further object of the present invention to provide a method for producing at least one of Si_xC_y and of Si_vN_w and a method for producing at least one of $Si_xC_yH_z$ and of $Si_vN_wH_u$ layers, which layers thus produced are extremely well suited for production of the optically effective layer at the information carriers mentioned above, but which methods may also be used for producing layers for different applications. The inventive methods shall fulfil at least one of the following objects:

- economic production, especially as concerns complexity of plants for performing these methods;
- accurate and relatively simple process control to realize desired stoichiometry characteristics of the layer material;
- realization at relatively low temperatures.

It is obvious that these objects, valid for the inventive methods, shall also be valid for the apparatus suited for performing such methods.

At least one of the objects mentioned above is realized by a method for producing a layer which at least predominantly consists of at least one, preferably just one of Si_xC_y and of $Si_vN_wH_u$ by means of a reactive vacuum coating process, which

method comprises the step of freeing silicon from a solid body into the process atmosphere and reacting the freed silicon in the process atmosphere with a reactive gas which contains at least one, preferably just one of C and N.

At least one of the objects mentioned above is further resolved by a method for producing a layer, which at least predominantly consists of at least one, preferably just one of $\text{Si}_x\text{C}_y\text{H}_z$ and of $\text{Si}_v\text{N}_w\text{H}_u$ by means of a reactive vacuum coating process, wherein an optimum of transmission of the layer and of refractive index of the material of the layer is achieved by means of adjusting the concentration of a gas in the process atmosphere, which gas contains at least two of C, N and H, preferably just C and H or N and H.

Preferred embodiments of the inventive information carrier, the method for producing layers and the apparatus for doing so will become apparent to the man skilled in this art when reading the following description of the invention as well as when considering the figures and the claims.

Brief description of the figures

The figures show:

- fig. 1 schematically, an inventive intermediate layer at an inventive information carrier under its generic aspect;
- fig. 2 schematically, a section of an inventive optical information carrier with two information-carrying solid material interfaces;
- fig. 3 in a representation according to fig. 2, a section of

an inventive information carrier with three information-carrying, solid material interfaces;

fig. 4 schematically, a first inventive apparatus for producing layers and for realizing the inventive methods for producing such layers;

fig. 5 schematically, a second and preferred embodiment of an inventive apparatus for realizing either of the inventive methods and with an inventive target.

In fig. 1 there is shown, principally, a section of a one-sided, bi- or multiple-reflecting information carrier according to the invention. An intermediate layer 3 is embedded between adjacent materials 2_o and 2_u . The intermediate layer comprises a dielectric layer 1 and a spacer layer 5. The latter consists preferably of a lacquer, especially of an ultra-violet hardenable lacquer as e.g. of a 2P-lacquer of the firm Philips.

The dielectric layer 1 far preferably consists of at least one of $Si_xC_yH_z$ and $Si_vN_wH_u$, thereby preferably of one of these materials, at least to a predominant amount, but can also at least predominantly consist of Si_xC_y and/or Si_vN_w . It could be that even materials such as ZrN or HfN or TiN, and thereby preferably ZrN, may be used as material for the dielectric layer 1.

Thereby, consisting is to be understood in the sense that there can be further components in the layer material, but with a substantially lower amount than the materials just mentioned above.

The material 2_u and layer 1 form a solid material interface

3_u. The material 2_o and the spacer layer 5 form a second solid material interface 3_o. At these two interfaces an informative structure is applied or may be applied by local modulation of surface characteristics, as e.g. for optical information carriers, of the geometric structure and, for magneto-optical carriers, of the magnetic characteristics.

The informative structure is shown in fig. 1 principally by means of areas 7. The modulated solid body characteristics, i.e. for instance the said geometrical surface structure or magnetic surface structure, modulate impinging electromagnetic radiation 9, as such radiation is shifted along the solid material interfaces 3_o and 3_u, as is perfectly known to the man skilled in this art.

The electromagnetic radiation 9 with an intensity I_0 is, on one hand, reflected at the first solid material interface 3_u, according to a reflected part $I_0 \cdot R_2$, wherein R_2 is the factor of reflectance. On the other hand, the part $I_0 \cdot (1 - R_2 - A_2) = I_0 \cdot T_2$ transits through the layer 3, wherein A_2 is the absorption at the layer and T_2 is the transmission through the layer. This part $I_0 \cdot T_2$ transits practically without loss through layer 5 and is reflected according to factor R_1 to become $I_0 \cdot R_1 \cdot T_2$. After having passed through layers 5 and 1 again, the radiation becomes $I_1 = I_0 \cdot T_2^2 \cdot R_1$. It is to be noted that the transmission T_2 enters as a quadratic term T_2^2 into the expression for I_1 .

The energy partitions, as explained and as shown in fig. 1, are approximations which do not take account of the negligible influence of the optically inactive spacer layer 5. With respect to the complicated higher order approximations of these energy considerations, we refer to "Optical Recording", Alan B. Marchant, Addison-Wesley, 1990, Publishing

Company, chapter 13, pages 344-353. The accurate distribution may be calculated with the help of the program "Film*STAR", Optical Thin Film Software, FTG Software Associates, P.O. Box 579, Princeton, N.J. 08542.

Required are two reflected beams ϑ_{out1} and ϑ_{out2} which are of an energy which is as equal as possible.

It is known to provide at the intermediate layer 3 a metal or metal-similar layer, as e.g. of Au, whereat, besides of the transmission T_2 , the reflection, too, very critically varies as a function of the geometric thickness D_G of the layer and which is expensive in production.

As was mentioned, in a far preferred embodiment of the inventive information carrier, the inventively applied layer 1 consists, at least predominantly, of Si_xC_y , $Si_xC_yH_z$, Si_vN_w or $Si_vN_wH_u$. The layer 1 thereby consists preferably of predominantly one of these materials; nevertheless, at least two of these four materials might be mixed.

The following preferred values and ratios for x, y, z and v, w, u were found:

1. It is clearly preferred that

1.1 $x \geq y$ and respectively $v \geq w$, irrespective of z and u.

1.1.1 Thereby it is further preferred that

$x \geq 1,2y$ and respectively $v \geq 1,2w$

and even more preferred

$x \geq 2y$ and respectively $v \geq 1,6w$, irrespective of z and u .

This is valid for material of predominantly one of the four mentioned compounds, but would also hold for material composed of two, three or four of these compounds.

Further there is thereby preferred:

2. $x \leq 0,8$, $y \geq 0,05$ and $z \geq 0,1$,

thereby especially

$x \leq 0,52$, $y \geq 0,1$ and $z \geq 0,2$,

$v \leq 0,8$, $w \geq 0,05$, preferably $w \geq 0,1$.

3. The following ratios are considered preferable:

3.1 $[0,445 : 0,262] \leq [x : y] \leq [0,775 : 0,078]$,

irrespective of the value of z and whether a single compound or multiple compound material is provided.

3.2 $[0,445 : 0,249] \leq [x : z] \leq [0,775 : 0,118]$,

irrespective of the value of y and whether a single compound or multiple compound material is provided.

3.3 $[0,078 : 0,249] \leq [y : z] \leq [0,262 : 0,118]$,

irrespective of the value of x and whether a

single compound or multiple compound material is provided.

- 3.4 In fact, it has been found that highest index of refraction of the material $\text{Si}_x\text{C}_y\text{H}_z$ is reached if
- $$x:y:z = 0,704 \ (\pm 10\%):0,087 \ (\pm 10\%):0,131 \ (\pm 10\%),$$
- is realized, $\pm 10\%$ indicating measuring accuracy and thus statistic dispersion of multiple measurement.

For lowest index of refraction still applicable, it has been found:

$$x:y:z = 0,494 \ (\pm 10\%):0,238 \ (\pm 10\%):0,226 \ (\pm 10\%).$$

- 3.5 $[0,527 : 0,401] \leq [v : w] \leq [0,858 : 0,099],$
- irrespective of the value of u and whether a single compound or multiple compound material is provided.

- 3.6 $[0,527 : 0,044] \leq [v : u] \leq [0,858 : 0,009],$
- irrespective of the value of w and whether a single compound or multiple compound material is provided.

- 3.7 $[0,099 : 0,044] \leq [w : u] \leq [0,401 : 0,009],$
- irrespective of the value of v and whether a single compound or multiple compound material is provided.

3.8 In fact, it has been found that highest index of refraction of the material Si_vN_w is reached if

$$v : w = 0,78 (\pm 10\%) : 0,11 (\pm 10\%),$$

irrespective of u . $\pm 10\%$ indicates statistic dispersion of multiple measurements.

For lowest index of refraction still applicable, it has been found:

$$v : w = 0,586 (\pm 10\%) : 0,364 (\pm 10\%),$$

irrespective of u .

This is especially valid if, as electromagnetic radiation γ , light at a wavelength λ_s is used for which there is valid:

$$400\text{nm} \leq \lambda_s \leq 800\text{nm},$$

and wherein there is especially preferably valid:

$$630\text{nm} \leq \lambda_s \leq 655\text{nm}.$$

In opposition to well-known applications of metallic layers for realizing the layer 1, the inventively provided layer 1, especially preferably of Si_xC_y and/or Si_vN_w or even more preferred of $\text{Si}_x\text{C}_y\text{H}_z$ and/or $\text{Si}_v\text{N}_w\text{H}_u$, makes use of interference, in that there is valid for the optical thickness D of layer 1:

$$D = m \cdot \lambda_o/4,$$

wherein m is an uneven integer of at least unity, but may be

reduced by an amount of up to 0,6 or increased by an amount of up to 0,2. λ_0 is the optical wavelength of the radiation ρ in the intermediate layer material, i.e. especially in the material of layer 1.

Thereby, reflection R_2 becomes significantly less critical with respect to the geometric thickness

$$D_G = \frac{n}{n} \cdot \lambda_0/4$$

(n: index of refraction)

as the optical thickness

$$D = m \cdot \lambda_0/4$$

may vary according to a reduction of m by a value up to 0,6 or an increase of m by a value up to 0,2.

Thus, D_G may be selected considerably smaller (thickness of layer!) than according to integer-valued m , whereby

- reflection is only insignificantly reduced,
- transmission is significantly increased.

The possibility of providing the layer with reduced thickness (D_G) further significantly increases economic production (increased feed-through).

The fact that generically the reflection is uncritical with respect to D_G further significantly lowers efforts for thickness control in layer production.

As the transmission T_2 appears quadratic at beam ρ_{out2} (see fig. 1), increase of T_2 largely improves the energy ratio at

the beam 9_{out1} and 9_{out2} to become equal. As was said, the transmission T_2 appears quadratic in the energy output at beam 9_{out2} . Thus, already a small reduction of geometric thickness leads to a significant improvement at this beam.

Further, the reflection homogeneity or distribution along solid material interface 3_0 becomes significantly less dependent on thickness distribution or thickness variations of D_G of the layer 1 on the material 2_u , which is with respect to the production method for depositing layer 1 a significant advantage.

The spacer layer 5, especially for optical information carriers, is preferably formed by a lacquer which may be surface structured, as e.g. by a lacquer "2P" of the firm Philips, i.e. by a lacquer which may be hardened by ultra-violet radiation ($\lambda_s < 400\text{nm}$).

The inventive layer 1 has intrinsically a high transmission (low absorption) in the ultra-violet range, which may even be improved by the possibility mentioned above, namely to reduce the geometric thickness D_G of layer 1 without significantly affecting reflection. Thereby, a transmission for ultra-violet range radiation is reached, which is at least 10%. The intermediate layer 3, especially at optical information carriers, is commonly deposited on a plastic material, as material 2_u , especially on surface structured polycarbonate or PMMA.

A significant advantage of the inventive layer 1 may be seen in the fact that the preferred layer materials Si_xC_y and $\text{Si}_x\text{C}_y\text{H}_z$ as well as the said plastic substrate materials and the said lacquer contain carbon, so that rigid adherence of the layer material is achieved with respect to the said

plastic material or lacquer.

So as to realize a reflection R_2 of $30 \pm 10\%$ between common substrate plastic materials, such as polycarbonate or PMMA, and the material of layer 1, a very high index of refraction n_1 is required for the layer material, because the index of refraction of the substrate material is already high: The index of refraction of polycarbonate is e.g. 1.57. If, on the other hand, at the inventively applied material of layer 1 the index of refraction n_1 is increased, this will simultaneously lead to a decrease of transmission T_2 , i.e. to an increase of absorption in the material of layer 1. The output signal from solid material interface 3_0 , according to fig. 1, is very critically dependent on a decrease of transmission T_2 (increase of absorption). By tailoring stoichiometry x/y and especially $x/y/z$, as was described above, it becomes possible to reach an optimum compromise of the contradictory requirements with respect to index of refraction and to transmission. Especially at the far preferred layer material $Si_xC_yH_z$ it becomes possible by varying two independent parameters, namely carbon content y and hydrogen content z , to optimally set the per se contradictory requirements. A preferred technique to realize such a setting shall be described later in context with the description of the inventive method for producing the layers.

With application of the inventive layer 1 of Si_xC_y , $Si_xC_yH_z$, Si_vN_w or $Si_vN_wH_u$, it became possible to realize reflections R_2 for light at $\lambda_s = 635\text{nm}$ at polycarbonate as material 2_u of between 20% and 40%. This led to energy transmitted into the intermediate layer 3 of between 60% and 80%, such energy impinging on the second solid material interface 3_0 , taking into account an absorption A_2 at the said wavelength λ_s of practically 0%. Reflection R_1 is optimized by appropriate

selection of the material 2_o according to fig. 1, and was, e.g. using Al as material 2_o , 81% of the energy impinging on the second solid material interface. Thus, and according to fig. 1, for a beam 9_{out1} of 20%, there resulted approximately a beam 9_{out2} of 52%, and for a beam 9_{out1} of 40% there resulted approximately a beam 9_{out2} of 29% of the impinging energy.

With a high degree of probability, the inventive intermediate layer 3 with the inventive layer 1 may also be used for radiation within the blue spectral range, i.e. for light wavelength according to $400\text{nm} \leq \lambda_s \leq 500\text{nm}$. Further, and in the sense of the hybrid MMCD described above, the inventive intermediate layer and layer may be used for applying radiation with selectively different wavelengths, as e.g. of 635nm and 785nm, for selectively reading information at one interface by light of one wavelength, and from the second interface by the light of the second wavelength. Thereby, and with an eye on fig. 1, if e.g. 635nm light is used to read information from interface 3_u and light of 785nm is used to read information from interface 3_o , then the optically effective layer 1 is tailored so that practically all 635nm light is reflected at R_2 and practically all 785nm light is transmitted onto solid material interface 3_o and is reflected there. This is achieved by making the geometric thickness D_G of layer 1 so as to accord with an odd number of quarter wavelengths with respect to the 635nm light, and simultaneously to accord with an even number of quarter wavelengths for the 785nm light.

As was mentioned above for an odd number of quarter wavelengths, m is

$$0,4 \leq m \leq 1,2;$$

(first order)

$$2,4 \leq m \leq 3,2;$$

(third order)

$$4,4 \leq m \leq 5,2; \quad \dots\dots$$

(5th order)

With respect to polycarbonate and most probably with respect to PMMA on one hand as well as most probably with respect to the UV-hardenable lacquers, the inventive layer 1 fulfils, with respect to adherence, the adherence tape tests according to MIL-M-13508C and/or MIL-C-00675B, as defined in H. Pulker, "Coatings on Glass", p. 358, Elsevier, 1984.

Fig. 2 shows a preferred embodiment of an inventive optical information carrier, realized by an optical storage disk with two information carrying solid material interfaces $3_o'$, $3_u'$.

On a substrate carrier $2_u'$, preferably made of polycarbonate or PMMA, a layer 1 is deposited according to the preferred specification under 1) to 3.8).

On the spacer layer 5 there is provided a metallic reflection layer $2_o'$ made of A_u or Ag, thereby preferably made of Al. The highly reflective layer $2_o'$ is covered with a covering layer 2_{od} .

At a further embodiment shown in fig. 3, the following layers are provided:

- carrier substrate $2_u'$ preferably made of polycarbonate or PMMA;
- layer 1 preferably made of the materials mentioned above, namely $Si_xC_yH_z$, Si_xC_y , $Si_vN_wH_u$ or Si_vN_w ;
- spacer layer 5 preferably made of ultra-violet hardenable lacquer, thereby preferably of a "2P" lacquer which de-

finishes the second solid material interface 3_{o1} with respect to a further inventive layer made preferably of $Si_xC_yH_z$, Si_xC_y , $Si_vN_wH_u$ or Si_vN_w ;

- spacer layer 5 preferably made of ultra-violet hardenable lacquer which forms the third solid material interface 3_{o2} with respect to a highly reflective metal, especially aluminum layer $2_{o'}$.

From each of the three solid material interfaces 3_u , 3_{o1} , 3_{o2} , there is, preferably again at a laser light wavelength of 635nm, reflected so much that each of the output beams S_1 to S_3 are of approximately 20% of the impinging energy I . The absorption of every "semi-transparent" inventive layer 1 is smaller than 2%, and the respective transmission T_2 is accordingly high.

The embodiment according to fig. 3 applied to the prescribed MMCD technique results in a storage capacity per one side of a 120mm CD of approximately 11GByte, whereas e.g. at a SD (super density disk) there results a storage capacity per side of approximately 13GByte and for a double-sided SD of approximately 27GByte.

In the following, the inventive method for producing especially the described layers 1 shall be described with the help of inventive reactive layer vacuum deposition apparatus, which latter may not just exclusively be used for the above mentioned "semi-transparent" layers 1 at the inventive information carrier, but which are especially suited for that object.

At the apparatus schematically shown in fig. 4, the "semi-transparent" layer 1 (figs. 1 to 3) is deposited by means of

ion plating, whereas in a preferred apparatus, according to fig. 5, and in a preferred manner, the inventive layer 1 is deposited by means of reactive sputter coating.

With the inventive methods of producing such layers - other methods appear possible, too -, as one most important aspect, the relation of transmission T_2 and index of refraction n_1 at the preferably deposited $Si_xC_yH_z$ and/or $Si_vN_wH_u$ layer is optimized by controlling the ratio of carbon to hydrogen. This is preferably realized by feeding at least two gases to the process atmosphere, which gases have different C/H or N/H content ratios each. Thereby, the content of these two gases in the process atmosphere may be open-loop controlled or negative feedback controlled. A second alternative or additional aspect is that silicon atoms are freed into the process atmosphere from a highly pure silicon solid body and react in the process atmosphere with carbon-, preferably with carbon- and hydrogen-containing gas. Under the first aspect, i.e. by controlling the amount of the said two gases in the process atmosphere, the optical parameters are optimized. By the second, a most economic and well controllable process is realized.

As a process discharge gas, preferably a noble gas as e.g. Ar, is used.

As reactive gases, carbon hydrogen gases, as e.g. Butane C_4H_{10} , Methane CH_4 , Propane C_3H_8 , Nitrogen N_2 or Nitrogen-hydrogen gases may be used, whereby, by open-loop or negative feedback loop controlling each gas flow to the process atmosphere, more or less carbon C or nitrogen N is introduced per time unit compared with hydrogen fed to the process chamber per time unit.

The silicon, freed from the silicon solid body source, allows use of low price solid body sources compared, e.g., with the case where SiC is freed from well-known graphite-doped silicon sources. By means of accurately predetermining the composition of the silicon of the solid body source, the overall layer deposition process becomes more controllable and, by varying process gas composition, adjustable.

According to fig. 4, which shows schematically an ion plating apparatus, a plasma discharge PL in a vacuum chamber 51, between electrodes 53 and 54, is maintained. By means of the discharge PL, silicon of a target 55, as shown at the electrode 54, is evaporated or sputtered into the process atmosphere. Instead (not shown) of a plasma discharge PL, there may also be used, and as known to the skilled expert, thermic evaporation of silicon, as e.g. by means of electron beam.

The plasma discharge PL may be operated either with Rf-voltage or with DC or with DC and superimposed Rf or with DC with superimposed medium frequency Mf-energy or with DC with superimposed low frequency Lf-signal, whereby, preferably, DC is used with superimposed Mf or Lf pulsating voltage.

It must be considered that the layer material produced in the process atmosphere as well as silicon per se are poorly electrically conducting, so that, with an eye on arcing and source poisoning by isolating layers, much care must be taken for appropriate process control.

In a far preferred embodiment as shown, the plasma discharge PL is operated by means of a DC source 57. Stability of the coating process is maintained in spite of the use of a low cost DC source 57, by superimposing to the output signal of the DC source U_+ , an AC voltage with a frequency in the me-

dium or low frequency range, which is preferably a pulsating voltage. As schematically shown, this AC voltage is preferably intermittently superimposed at a superposition unit 58 to the output DC signal of source 57. Such signal superposition is preferably realized by interconnecting the two discharge electrodes 53 and 54 intermittently by means of the chopper unit 59, which intermittently interconnects these electrodes alternatively high ohmically and low ohmically. This preferred technique is shown in broken lines. Either a predetermined fixed chopper repetition rate and/or duty cycle is used or, and preferably, the occurrence of disturbance arcing is automatically monitored in the process recipient and controls via chopper unit 59 low ohmic connection of the two discharge electrodes 53 and 54, thereby preventing arcing.

This superposition technique is described completely and in detail in the European application no. 0 564 789 which accords with the U.S. application no. 08/020 672 or 08/300 865 and to the Japanese application no. 5-65052.

With respect to this preferably used chopping technique, the said patents and applications shall be considered as integrated part of the present description; the U.S. application 08/300 865 is enclosed to this specification as an appendix A.

In the vacuum chamber 51, there is further provided a work-piece carrier electrode 60, which, e.g. with respect to electrode 54, is fed with a negative DC electric potential by means of a DC source 62. Here, too, a superposition unit, as was described, realized preferably by means of a chopper unit 64, according to the predescribed chopper unit 59, allows to maintain stability of the layer deposition process at the

workpiece carrier electrode 60. With respect to electric potential, which is applied to the housing of the chamber, the electrodes 53, 54 and 60, the skilled expert knows different possibilities, also with respect to defining and applying reference, i.e. ground potential.

Inventively, a gas tank arrangement 66 is provided, from which a reactive gas G containing carbon C and/or nitrogen N_2 and preferably further hydrogen H is fed to the chamber 51, i.e. into the process atmosphere. This besides a plasma discharge working gas, which is normally selected to be Ar. Preferably, the gas G results from controlled mixing of two gases G_1 and G_2 , as schematically shown, by means of controllable valves V_1 and V_2 . If the two gases, as e.g. Propane and Butane or Nitrogen and Ammonia, have different stoichiometric ratios (e.g. Butane 2,5; Propane 2,7), the control of varying contents of the gases G_1/G_2 in the process atmosphere controls the ratio of C/H or respectively of N/H in that atmosphere, and thus at the $Si_xC_yH_z$ or $Si_vN_wH_u$ layer which is growing. Thus, by means of two independent parameters, namely the C and H or N and H content, the transmission T_2 and the index of refraction n_1 at the growing $Si_xC_yH_z$ or $Si_vN_wH_u$ layer is controlled.

If only one gas is used as a reactive gas, preferably Propane is used for $Si_xC_yH_z$ and Nitrogen for Si_vN_w .

Today, layer deposition is preferably realized by magnetron sputtering. Fig. 5 schematically shows, as an example, an apparatus for such magnetron sputtering. From the magnetron source 70, silicon is freed into the process atmosphere of the vacuum recipient 71. The magnetron electrode 70 is connected to a workpiece carrier electrode 73 via a DC source 75, as was described, whereby, again, a chopper arrangement

77 of the kind which was mentioned above is used (shown in dashed lines). This is a preferred realization of superimposing an AC voltage to the output DC voltage of the DC source 75 at the superposition unit 78. Thereby, again, the AC voltage is preferably selected as a medium frequency or low frequency signal, and is preferably pulsating.

In the operating mode with a DC-driven plasma discharge PL at ion plating according to fig. 4 and especially for DC operated sputtering according to fig. 5, an inventive silicon target is preferably used, which is negatively or positively doped, preferably with Boron and/or Phosphor. Thereby, preferably the specific resistance of the target material made of doped silicon, ρ_{Si} , is:

$$0,01\Omega\text{cm} \leq \rho_{Si} \leq 6\Omega\text{cm}.$$

Thereby, in a preferred mode, the following is valid:

$$0,4\Omega\text{cm} \leq \rho_{Si} \leq 0,6\Omega\text{cm}.$$

By this it is achieved that the per se low conductive silicon has an increased conductance ρ_{Si}^{-1} and may be even DC sputtered or, as was explained, preferably sputtered by means of a DC voltage with superimposed AC component. Thereby, as we described, parallel chopper technique is preferably used.

This mode of operation allows a most economic operation at a high deposition rate, whereby the silicon allows further to reach a high layer quality due to the fact that it is sputtered without arcing and without occurrence of droplet.

The reactive gas G is applied as a single gas or as a gas mixture, as was explained with respect to fig. 4. The layers

may be deposited with a magnetron source 70, as known per se, so e.g. by placing the carrier substrates just in front of the target. The carrier substrate may also be moved along the target, so e.g. in linear in-line coaters, or may be rotated passing the target, as e.g. in plants with rotating cylindrical workpiece carriers.

Before results are presented, the advantages of the inventive information carriers and of the inventive method of producing layers and thus of apparatus suited to perform such methods shall be listed in summarized form:

With respect to the information carrier with inventive intermediate layer:

- At a selected wavelength (preferably 635nm) of the electromagnetic radiation for applying and especially for reading information from the solid material interfaces, between which at least one inventive intermediate layer with layer 1 is situated, a high transmission T_2 of the intermediate layer is reached, and a high reflection at a surface of the intermediate layer (figs. 1 to 3).
- The transmission T_2 of the inventively provided layer 1 is high for ultra-violet light ($\geq 10\%$), so that lacquers, which are applied and which are ultra-violet hardenable, may be hardened by ultra-violet radiation transmitted through the layer 1 with a high effectiveness.
- Adherence of the layer 1 with respect to covering materials which comprise C, as especially with respect to plastic materials, thereby especially to polycarbonate or PMMA, and with respect to the ultra-violet hardenable lacquers as mentioned is high, because the material of

the inventive layer also comprises the element C.

- By deposition of the layer 1 with an optical thickness, which substantially accords with an uneven number of quarter wavelength with respect to the wavelength of the radiation considered, the reflection becomes less critical with respect to the exact geometric thickness of the intermediate layer, and additionally it becomes possible to increase transmission of that layer by depositing layer 1 with reduced thickness ($m - 0.6$) than is defined by the uneven integer number m of $\lambda_0/4$ optical thickness.
- Especially with using $\text{Si}_x\text{C}_y\text{H}_z$ or $\text{Si}_v\text{N}_w\text{H}_u$ layer material for layer 1, i.e. with C and H or with N and H, two independent parameters for tailoring transmission and reflection of the layer 1 and the intermediate layer respectively are exploitable.
- The inventive intermediate layer with the layer 1 opens the possibility of economic, easily controllable manufacturing processes and of their realization by means of low cost apparatus.

With respect to the method of producing layers:

- The use especially of doped silicon targets is economic and simple, the according targets are easily manufacturable.
- By applying gases which contain carbon, hydrogen or Nitrogen, relatively low cost and safe gases are used.
- By the use of a DC coating technique with the AC superposition which was described, expensive high power AC

generators become obsolete. Arcing and other process instabilities are nevertheless accurately avoided, although low cost and technically simple generators are used.

1. Example:

An $\text{Si}_x\text{C}_y\text{H}_z$ layer was deposited on a polycarbonate substrate. Thereby, an apparatus was used as principally shown in fig. 5. The substrates were deposited on a cylindric carrier and were rotated passing a rectangular magnetron source. Thereby, the minimum distance between substrates and target surface was 70mm.

Target material:	Si (99,99%), p-doped with Boron, $\rho_{\text{Si}} = 0,5\Omega\text{cm};$
Discharge current feed:	10kW/DC with chopper unit according to 77 of fig. 5;
Discharge operating gas:	Ar;
Reactive gas:	Propane, C_3H_8 ;
Reactive mode / metallic mode:	Negative feedback control by monitoring the deposition process with the help of a plasma emission monitor and adjusting chopper unit 77 as well as the flow of Argon and Propane by means of adjustable controllers according to V_1/V_2 of fig. 4;
Discharge power:	7kW;

Rotational frequency of
workpiece carrier 73: 0,5Hz.

In the following table, three batches no. 2, 3 and 4 are
specified with respect to coating process parameters.

Batch	Power kW	Argon flow sccm	Gas pressure e-3mbar	Metallic mode voltage UMM V	Reactive mode voltage URM V	Propane flow qC ₃ H ₈ sccm	Flow ratio qC ₃ H ₈ :qAR	Sputtering time s
2	7	25.5	4	807	777-780	5.9	23.14%	377
3	7	25.5	4	800	724	12	47.06%	377
4	7	25.5	4	828	765	11.4	44.71%	225

At the batches no. 2, 3 and 4, the following values were
measured:

Batch	Index of refraction at 635nm n	Extinction coefficient k at 635nm k	Reflection at 635nm %
2	3.19	1.47	38
3	2.28	0.35	13
4	2.59	0.67	23

By the inventive Si_xC_yH_z coatings applied to polycarbonate
substrates, at batch no. 4 a reflection of 40% was measured
at a wavelength of 635nm and from the layer-to-air-side. The
amount of transmitted light through the polycarbonate carrier
substrate with a thickness of 1.2mm and with the inventive
layer thereon was 60% at the wavelength of 635nm, which
accords with the transmission T₂ of practically a 100%, i.e.
to an absorption of practically 0%, which is thus neglect-
able. The amount of transmitted energy at a wavelength of
360nm was still 12%. At the batches no. 2 to 4, as specified
above, the following stoichiometry was achieved:

Batch No.	Si	:	C	:	H	:	O
no. 2	0.529	:	0.116	:	0.295	:	0.06
no. 3	0.401	:	0.227	:	0.29	:	0.082
no. 4	0.42	:	0.203	:	0.33	:	0.047

There resulted, with an eye on fig. 1,

$$0,2 \leq R_2 \leq 0,4 \text{ and}$$

$$0,2 \leq (R_1 \cdot T_2^2) \leq 0,4.$$

As band for the index of refraction, we first propose: $2,59 \leq n_1 \leq 3,2$ for polycarbonate substrate material.

For the index of refraction k , we first propose the following values:

$$k_{300\text{nm}} \leq 1,5 \text{ and}$$

$$\begin{aligned} \text{and/or} \quad & k_{600-700\text{nm}} \leq 0,5, \\ \text{especially} \quad & k_{600-700\text{nm}} \leq 0,1, \end{aligned}$$

$$\text{and/or} \quad k_{450-500\text{nm}} \leq 1.$$

By the realization of an information carrier structure according to fig. 3 with the deposition processes as disclosed above, the beams S_1 to S_3 had about 20% of impinging energy at an absorption of 2% at most for light at the wavelength of $\lambda_s = 635\text{nm}$.

2. Example:

As a result of the first example mentioned above, we noted

that with stoichiometric or nearly stoichiometric semitransparent layers made of SiC, we reached index of refraction n_1 , not really exceeding the value of 3.2 at a wavelength of 633nm. On the other hand, it first seemed impossible to use a more accentuated unstoichiometry and thus higher index of refraction because of the large k-value which were supposed to occur. It further seemed impossible to reach a signal spex of 25% for the blue laser at 450nm wavelength.

Nevertheless, the inventors went on with further experiments that showed that higher index materials would allow to use thinner layers, so that, even with increased k-value materials, the transparency decrease would not be detrimental. Thus, and as will be shown in this example, index of refraction well above 4, up to 4.6 and specifically at 4.2, were reached with k-values $k_{350\text{nm}} \leq 2,5$, $k_{600-700\text{nm}} \leq 0,5$ and $k_{450-500\text{nm}} \leq 1$.

Using Si as target material, high index of refraction layers were realized by reactive sputtering in nitrogen instead of hydrogenic carbon gas according to example 1. Even experimenting on a more stoichiometric version of $\text{Si}_x\text{C}_y\text{H}_z$ showed that it is possible to reach, even at 450nm, 25% signals from both information layers.

$\text{Si}_x\text{C}_y\text{H}_z$, Si_xC_y , $\text{Si}_v\text{N}_w\text{H}_u$ and Si_vN_w layers were deposited on polycarbonate substrates. Although an apparatus as shown in fig. 5 could be used, an SDS 100 apparatus of Balzers was used where the substrate is kept stationarily with respect to the target.

Substrate-to-target distance: 40mm

Approximate reaction volume: 5000cm³

Target material: as in example 1.

Discharge current fee: as in example 1.

Discharge operating gas: as in example 1.

Reactive gases: Methane for Si_xC_y and $\text{Si}_x\text{C}_y\text{H}_z$.

Nitrogen and ammonia for: Si_vN_w and $\text{Si}_v\text{N}_w\text{H}_u$.

Discharge power: 4kW.

In the following table, four typical batches with highest index of refraction reached and lowest index of refraction reached and still applicable are specified with respect to coating parameters, indicating the preferred range for digital-video disk coatings made of silicon carbides or silicon nitrides.

Table 1: Process parameters and resulting n and k values

batch	layer	flow N2	flow CH4	flow Ar	voltage V	n633nm	k633nm	k350nm	n450	k450
6	Si_vN_w	4	0	32	540	4.19	.5	2.43		
12	Si_vN_w	14	0	32	542	3.02	.18	1.01		
42	Si_xC_y	0	4	32	557	3.97	.24	2.33	4.35	1
45	Si_xC_y	0	16	32	555	2.81	.03	0.95	3.04	0.33

Table 2 shows measured and calculated results, the reflectance R and the transmittance T measurements were done by a Lambda-9 spectral photometer of Perkin Elmer on corning test

substrates. From the R-T measurements, n and k values have been calculated. From the n and k values, the optimal thickness for highest possible signals S_1 and S_2 from both information carrying interfaces valid within the stack were calculated using the Film Star Program mentioned above. The optimal index giving the highest possible signals lies for SiC between $n = 3,97$ and $n = 2,81$. At $n = 3,13$ and $k = 0,06$ one gets signals of $S_1 = S_2 = 32,2\%$, i.e. only 2,4% below the theoretical limit when Al is used as high reflecting back layer.

Table 3 shows the corresponding stoichiometry to the postulated limiting index of refractions useful for digital-video disk applications.

Table 2: R-T measurements in air and maximal possible signals from the info-layers S_1 , S_2 for the corresponding optical constants n and k

Red-laser results:

batch	reflectance at 633nm	transmittance at 633nm	thickness measured	calculated optimal thickness	signal of 1st info-layer	signal of 2nd info-layer
	R %	T %	dm nm	dopt nm	S1 %	S2 %
6	62.2	23.2	35.1	15.2	25	25
12	47.8	41.8	51.3	48	28	28
42	63.4	28.1	39.1	18.5	29	29
45	46.3	51.5	57.4	56.3	26.2	40.8

Blue-laser results:

batch	reflectance at 450nm	transmittance at 450nm	thickness measured	calculated optimal thickness	signal of 1st info-layer	signal of 2nd info-layer
	R	T	dm	dopt	S1	S2
	%	%	nm	nm	%	%
42	38	36.4	39.1	9.2	21	21
45	28	40.5	57.4	34	25	25

Table 3: Stoichiometry of the batches benchmarking the limits ($\pm 10\%$) of useful refractive indices for DVDs

batch	Si	O	N	C	H	n633nm	n450nm
	%	%	%	%	%		
6	78	5	11	2	4	4.19	
12	58.6	2	36.4	2	1	3.02	
42	70.4	7.8	0	8.7	13.1	3.97	4.35
45	49.4	4.2	0	23.8	22.6	2.81	3.04

Thus, as a band for the index of refraction, according to the present invention, we finally propose:

$$2.59 \leq n_1 \leq 4,6, \text{ thereby especially } 2,8 \leq n_1 \leq 3,2.$$

For the index of refraction k , we finally propose the following values:

$$k_{300\text{nm}} \leq 3,0 \text{ and/or } k_{350\text{nm}} \leq 2,7 \text{ and/or}$$

$$k_{600-700\text{nm}} \leq 0,5, \text{ especially } \leq 0,1, \text{ and/or } k_{450-500\text{nm}} \leq 1.$$

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Resuming the present invention, the following objects are resolved:

- low cost manufacturing due to the fact that, exploiting the proposed stoichiometries, very thin layers may be used which drastically reduces manufacturing time;
- matching of multiple reflected beams;
- possibility to adjust signal levels to player capabilities;
- possibility to adjust the signal levels reached to the thickness distribution performance realizable with a specific coating chamber;
- improved adherence on chamber walls and masks for metallic-like layers to reduce flaking-off problems;
- simpler process control in that it is possible to work near the metallic deposition mode. The closer one can work in a reactive process to the metallic mode, the smaller is the danger to abruptly and uncontrollably jump into reactive mode;
- the use of nitrogen instead of propane or methane additionally reduces security measures.
- realization of 25% signals from two information carrying interfaces even with a blue laser at 450nm.

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Claims:

1. Information carrier, comprising at least two solid material interfaces at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces, further comprising at least one intermediate layer between said two solid material interfaces, which layer transmitting said radiation, said intermediate layer comprising a layer at least predominantly consisting of at least one of Si_xC_y and of Si_yN_w .

2. Information carrier, comprising at least two solid material interfaces at which information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces, further comprising at least one intermediate layer between said two solid material interfaces, which layer transmitting said radiation, said information being readable from at least one of said solid material interfaces by means of radiation of predetermined wavelength, wherein said intermediate layer comprises a dielectric layer system with at least one layer, said layer system having an optical thickness which, at least in a first approximation, is $m \cdot \lambda_0/4$, wherein m is integer, at least unity and is uneven and wherein λ_0 designates the wavelength of said radiation which is transmitted through said at least one dielectric layer of said dielectric layer system, wherein, departing from said m being integer, m may be reduced by an amount of up to 0,6 or increased by an amount of up to 0,2.

3. The information carrier according to claim 2, wherein

said dielectric layer system at least predominantly consists of at least one of Si_xC_y and of Si_vN_w .

4. The information carrier according to one of the claims 1 to 3, wherein said locally modulated characteristic is the thickness of a solid material body defining at least one of said solid material interfaces.

5. The information carrier according to one of the claims 1 to 3, wherein electromagnetic radiation for at least one of applying said information and of reading said information has a wavelength within the wavelength band of

$$400\text{nm} \leq \lambda_s \leq 800\text{nm}.$$

6. The information carrier according to claim 5, wherein said band is

$$\begin{aligned} &630\text{nm} \leq \lambda_s \leq 655\text{nm}, \\ \text{especially} \quad &633\text{nm} \leq \lambda_s \leq 650\text{nm}. \end{aligned}$$

7. The information carrier according to one of the claims 1 to 3, wherein reflection at at least one of said solid material interfaces is 20% to 40% (both limits included) for a predetermined wavelength of said radiation.

8. The information carrier according to claim 7, wherein said predetermined wavelength is within at least one of the

$$400\text{nm} \leq \lambda_s \leq 800\text{nm} \text{ band and of the}$$

$$\begin{aligned} &630\text{nm} \leq \lambda_s \leq 655\text{nm} \text{ band}, \\ \text{especially} \quad &633\text{nm} \leq \lambda_s \leq 650\text{nm}. \end{aligned}$$

9. The information carrier according to claim 7, said reflection being valid for a first wavelength at a first of said solid material interfaces and for a second wavelength at the second solid material interface, reflection of radiation of said second wavelength at said first solid material interface being significantly lower than of radiation of said first wavelength.

10. The information carrier according to claim 9, said first wavelength being approximately 635nm or approximately 650nm.

11. The information carrier according to claim 9, wherein said intermediate layer comprises at least one dielectric layer having an optical thickness which is an at least approximately uneven multiple of a quarter of one of said first and second wavelengths and is at least approximately an even multiple of a quarter of the other of said first and second wavelengths.

12. The information carrier according to claim 9, wherein said second wavelength is approximately 785nm.

13. The information carrier according to claim 9, wherein said reflection of said radiation at said second wavelength and at said first solid material interface is 10% at most.

14. The information carrier according to one of the claims 1 to 3, wherein at least one is valid:

a) the index of refraction n_1 of said intermediate layer is:

$$2,59 \leq n_1 \leq 4,6.$$

- b) the extinction coefficient k of said intermediate layer is at least one of:

	$k_{300\text{nm}} \leq 3,0;$
especially	$k_{300\text{nm}} \leq 1,5,$ and
especially of	$k_{350\text{nm}} \leq 2,7,$
and of	$k_{600-700\text{nm}} \leq 0,5.$

15. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises a spacer layer.

16. The information carrier according to claim 15, wherein said spacer layer consists of at least one of a lacquer and of a glue.

17. The information carrier according to claim 2 or 3, wherein said dielectric layer consists at least predominantly of at least one of the materials of the group ZrN, HfN, TiN.

18. The information carrier according to claim 17, wherein said dielectric layer at least predominantly consists of ZrN.

19. The information carrier according to one of the claims 1 to 3, wherein one of said solid material interfaces is formed between said intermediate layer and a plastic material or between said intermediate layer and a spacer layer or between said intermediate layer and a high reflecting cover layer.

20. The information carrier according to claim 19, wherein at least one of the following is valid:

- said plastic material is one of polycarbonate and of PMMA,

- said spacer layer is at least predominantly of at least one of lacquer and glue,
- said high reflecting cover layer is at least predominantly of at least one of Al, Au, Ag.

21. The information carrier according to claim 20, said high reflecting cover layer consisting at least predominantly of Al.

22. The information carrier according to one of the claims 1 to 3, wherein one of said solid material interfaces is formed at a lacquer surface.

23. The information carrier according to claim 22, wherein said lacquer is hardenable by means of ultra-violet radiation.

24. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one semiconductor doping material.

25. The information carrier according to claim 24, wherein said doping material is at least one of Boron and Phosphor.

26. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises C and forms at least one of said solid material interfaces with a further material which contains C as well.

27. The information carrier according to one of the claims 1 to 3, wherein radiation in the blue spectral range of $400\text{nm} \leq \lambda_s \leq 500\text{nm}$ performs at least one of reading and writing of said information.

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28. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_xC_y and of $\text{Si}_x\text{C}_y\text{H}_z$, wherein $x \geq y$.

29. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_vN_w and $\text{Si}_v\text{N}_w\text{H}_u$, wherein $v \geq w$.

30. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_xC_y and $\text{Si}_x\text{C}_y\text{H}_z$ and wherein $x \geq 1,2y$.

31. The information carrier according to claim 30, wherein $x \geq 2y$.

32. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_vN_w and of $\text{Si}_v\text{N}_w\text{H}_u$ and wherein $v \geq 1,2w$.

33. The information carrier according to claim 32, wherein $v \geq 1,6w$.

34. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises $\text{Si}_x\text{C}_y\text{H}_z$ and wherein there is valid:

$$x \leq 0,8, y \geq 0,05 \text{ and } z \geq 0,1.$$

35. The information carrier according to claim 34, wherein there is valid:

$$x \leq 0,52,$$

$$y \geq 0,1,$$

$$z \geq 0,2.$$

36. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of $\text{Si}_v\text{N}_w\text{H}_u$ and Si_vN_w and wherein there is valid:

$$\begin{aligned}v &\leq 0,8, \\w &\geq 0,05.\end{aligned}$$

37. The information carrier according to claim 36, wherein there is valid:

$$w \geq 0,1.$$

38. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_xC_y and $\text{Si}_x\text{C}_y\text{H}_z$ and wherein there is valid:

$$\{0,445 : 0,262\} \leq \{x : y\} \leq \{0,775 : 0,078\}.$$

39. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_xC_y and $\text{Si}_x\text{C}_y\text{H}_z$ and wherein there is valid:

$$\{0,445 : 0,249\} \leq \{x : z\} \leq \{0,775 : 0,118\}.$$

40. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_xC_y and $\text{Si}_x\text{C}_y\text{H}_z$ and wherein there is valid:

$$\{0,078 : 0,249\} \leq \{y : z\} \leq \{0,262 : 0,118\}.$$

41. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer at least predominantly consists of $\text{Si}_x\text{C}_y\text{H}_z$ and wherein there is valid:

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$$x:y:z = 0,704 (\pm 10\%) : 0,087 (\pm 10\%) : 0,131 (\pm 10\%),$$

wherein $\pm 10\%$ indicates the statistic dispersion of multiple measurements of the values.

42. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer at least predominantly consists of $Si_xC_yH_z$ and wherein there is valid:

$$x:y:z = 0,494 (\pm 10\%) : 0,238 (\pm 10\%) : 0,226 (\pm 10\%),$$

wherein $\pm 10\%$ indicates the statistic dispersion of multiple measurements of said values.

43. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_vN_w and $Si_wN_wH_u$ and wherein there is valid:

$$\{0,527 : 0,401\} \leq \{v : w\} \leq \{0,858 : 0,099\}.$$

44. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_vN_w and $Si_vN_wH_u$ and wherein there is valid:

$$\{0,527 : 0,044\} \leq \{v : u\} \leq \{0,858 : 0,009\}.$$

45. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_vN_w and $Si_vN_wH_u$ and wherein there is valid:

$$\{0,099 : 0,044\} \leq \{v : u\} \leq \{0,401 : 0,009\}.$$

46. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one

of Si_vN_w and $\text{Si}_v\text{N}_w\text{H}_u$ and wherein there is valid:

$$v : w = 0,78 (\pm 10\%) : 0,11 (\pm 10\%),$$

wherein $\pm 10\%$ indicates statistic dispersion of multiple measurements.

47. The information carrier according to one of the claims 1 to 3, wherein said intermediate layer comprises at least one of Si_vN_w and $\text{Si}_v\text{N}_w\text{H}_u$ and wherein there is valid:

$$v : w = 0,586 (\pm 10\%) : 0,364 (\pm 10\%),$$

wherein $\pm 10\%$ indicates statistic dispersion of multiple measurements.

48. The information carrier according to one of the claims 1 to 3, wherein adherence of said intermediate layer on an adjacent solid material of the carrier withstands at least one of the tests according to MIL-M-13508C and of MIL-C-00675B as defined in H. Pulker, "Coatings on Glass", Elsevier, 1984, p. 358.

49. The information carrier according to one of the claims 1 to 3, wherein at least three of said solid material interfaces are provided on one side of a carrier substrate.

50. The information carrier according to one of the claims 1 to 3, with an information storage capacity per side of a carrier substrate of at least 11GByte at a diameter of a circular carrier of 120mm.

51. The information carrier according to claim 50, said storage capacity being 13GByte.

52. A method for producing a layer at least predominantly consisting of at least one of Si_xC_y and of Si_vN_w by means of a reactive vacuum coating process, comprising the step of freeing Si from a solid body into the process atmosphere, reacting said freed Si in the process atmosphere with a reactive gas containing at least one of C and N.

53. A method for producing a layer at least predominantly consisting of at least one of $\text{Si}_x\text{C}_y\text{H}_z$ and of $\text{Si}_v\text{N}_w\text{H}_u$ by means of a reactive vacuum coating process, wherein an optimum of transmission of said layer and of refractive index of the material of said layer is achieved by means of adjusting the concentration of a gas in the process atmosphere, which gas comprises at least two of C, N and H.

54. The method according to claim 53, wherein Si is freed into the process atmosphere from a solid body.

55. The method according to one of the claims 52 to 54, wherein said gas in said process atmosphere at least predominantly consists of two different gases with different ratios of at least one of C content to H content and of N content to H content and wherein said optimum is one of open-loop- and of negative-feedback-controlled by adjusting the ratio of amount of said two gases in said process atmosphere.

56. The method according to one of the claims 52 to 54, further comprising applying between a carrier for workpieces, whereon said layer is produced, and an electrode in a vacuum atmosphere a DC-voltage and superimposing to said DC-voltage an AC-voltage.

57. The method according to claim 56, wherein said AC-voltage superimposed to said DC-voltage is a pulsating voltage.

58. The method according to claim 56, wherein said AC-voltage is generated by intermittently connecting said carrier and said electrode via a first current path and a second current path, which second current path having a considerably lower resistance than said first current path.

59. The method according to one of the claims 55 to 57, comprising one of reactive sputtering and of ion plating for said reactive vacuum coating.

60. The method according to claim 59, wherein said sputtering is performed by magnetron sputtering.

61. The method according to one of the claims 52 to 57, wherein a target of negative or positive doped silicon is one of reactively sputtered, ion plated and reactive magnetron sputtered.

62. The method according to one of the claims 52 to 54, further comprising the step of feeding a reactive gas with at least one of hydrocarbon and of hydronitrogen to said process atmosphere.

63. The method according to claim 62, wherein said reactive gas is at least one of the group of Propane, Butane, Methane and Ammonia.

64. The method according to claim 62, wherein said reactive gas is at least one of Propane and Nitrogen.

65. The method according to one of the claims 52 to 54, wherein said layer is produced as a layer of an intermediate layer between two solid material interfaces of an information carrier, at which interfaces information is or may be

applied, and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces.

66. The method according to one of the claims 52 to 54, wherein said layer is produced at an information carrier as an intermediate layer between two solid material interfaces, which intermediate layer comprises a dielectric layer system with at least one layer, at which interfaces information is or may be applied and whereat the information is stored by local modulation of at least one solid material characteristic, from which characteristic reflection of electromagnetic radiation depends at said interfaces, wherein said layer system has an optical thickness which, at least in a first approximation, is $m \cdot \lambda_0/4$, wherein m is integer and at least unity and is uneven and wherein λ_0 designates the wavelength of said radiation which is transmitted through said at least one dielectric layer of said dielectric layer system.

67. An apparatus for producing a layer at least predominantly of one of Si_xC_y , $\text{Si}_x\text{C}_y\text{H}_z$, Si_vN_w , $\text{Si}_v\text{N}_w\text{H}_u$, comprising a vacuum recipient with a workpiece carrier electrode therein and a solid body material source, which frees silicon into said vacuum recipient, and further comprising a gas inlet which is connected to a gas reservoir with a gas containing at least one of C and N.

68. The apparatus according to claim 67, wherein said gas inlet is connected with at least two gas reservoirs, wherein gases are contained with different ratios of at least one of C to H and N to H content.

69. The apparatus according to one of the claims 67 or 68,

wherein said workpiece carrier electrode and a further electrode in said vacuum recipient are interconnected via a DC-voltage source and a superposition unit, an AC-source being connected to said superposition unit.

70. The apparatus according to claim 69, wherein said AC-source generates a pulsating voltage superimposed to DC-voltage of said DC-voltage source at said superposition unit.

71. The apparatus according to one of the claims 67 or 68, wherein said workpiece carrier electrode and a further electrode in said vacuum recipient are interconnected via a DC-voltage source and a chopper unit connected parallel to said DC-source and parallel to said workpiece carrier electrode and further electrode, said chopper unit intermittently connecting said workpiece carrier electrode and said further electrode high ohmically and lower ohmically.

72. The apparatus according to one of the claims 67 or 68 being a sputtering apparatus.

73. The apparatus according to one of the claims 67 or 68 being an ion plating apparatus.

74. A target for vacuum coating process, consisting of negatively or positively doped silicon.

75. The target according to claim 74 being doped with at least one of Boron and Phosphor.



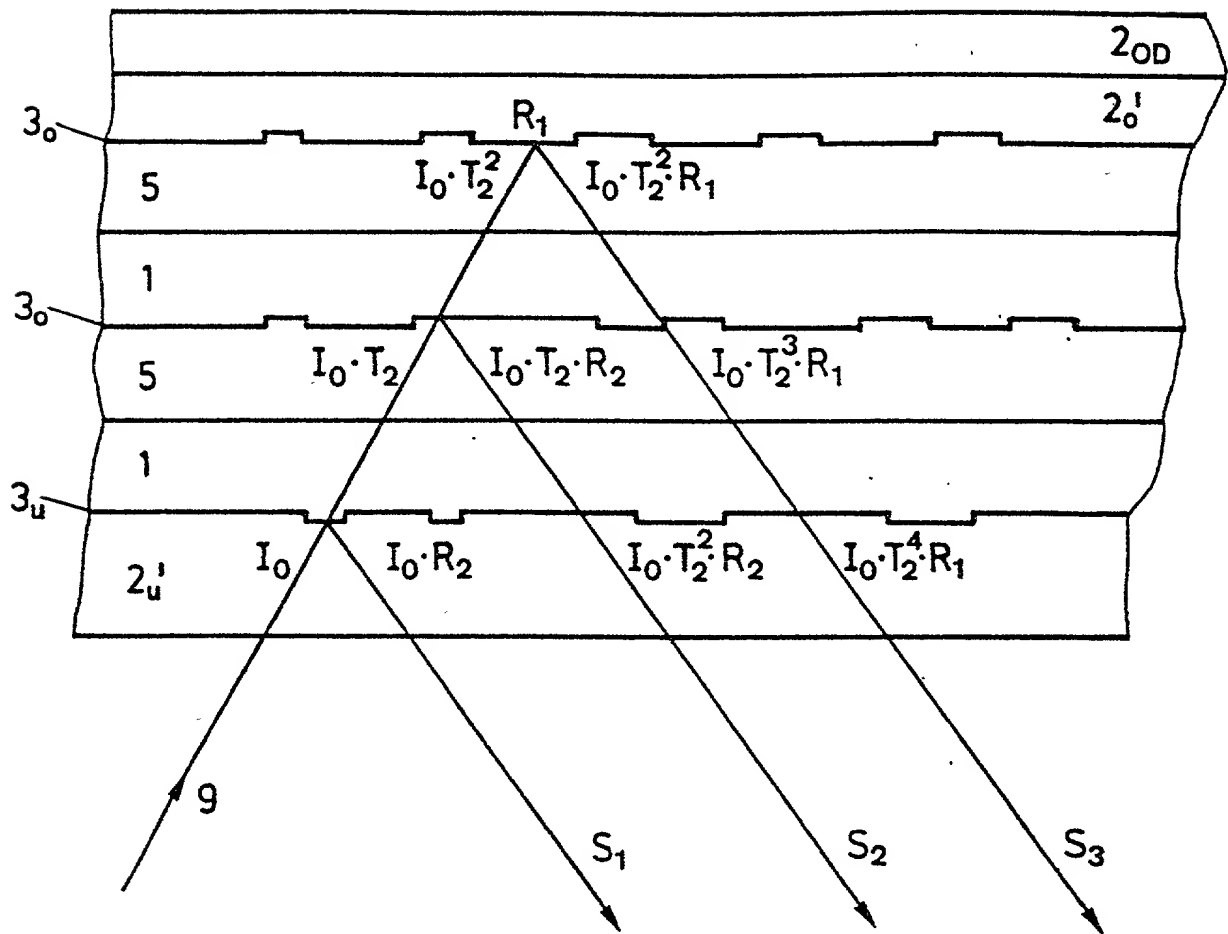


FIG. 3

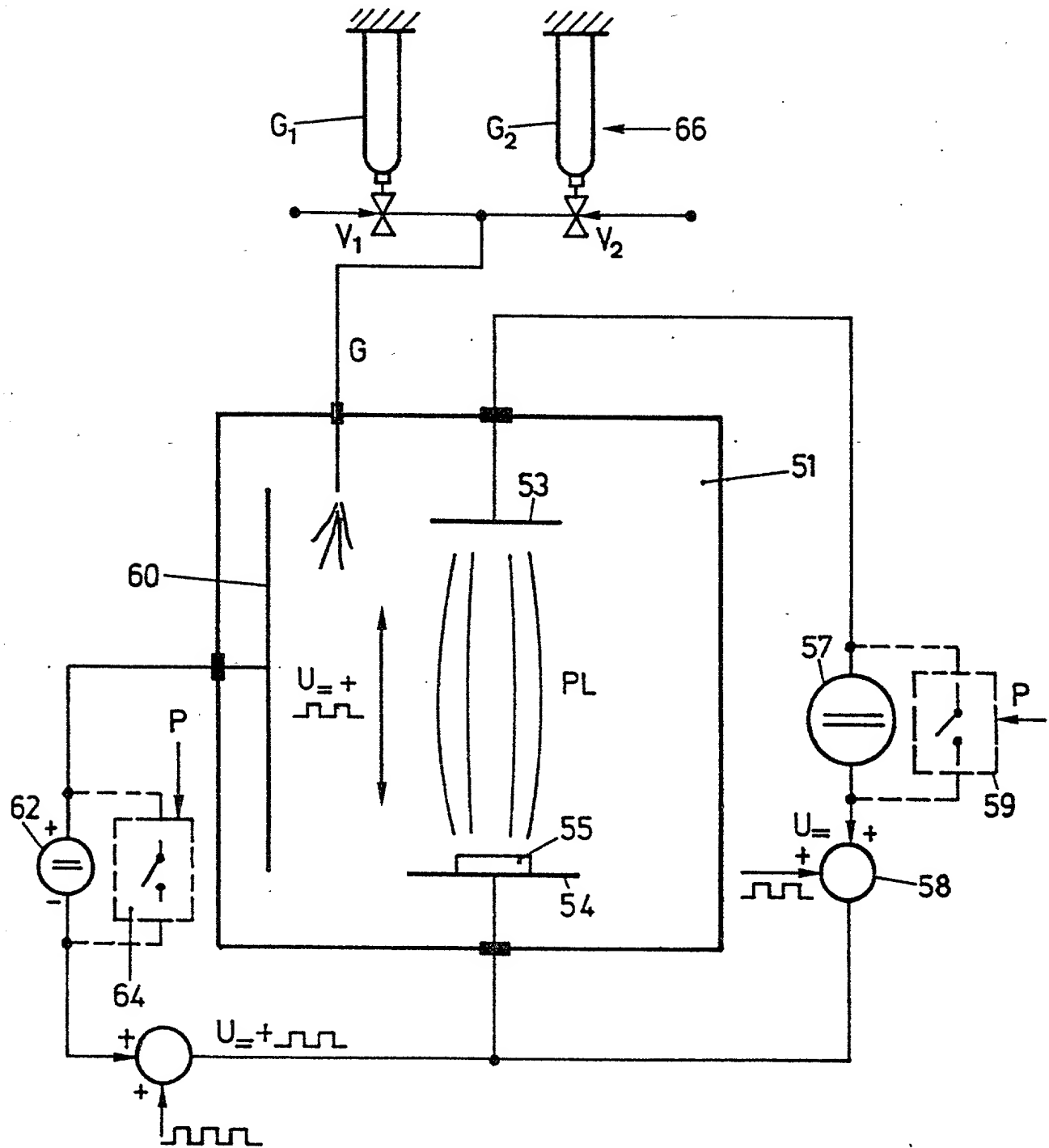


FIG. 4

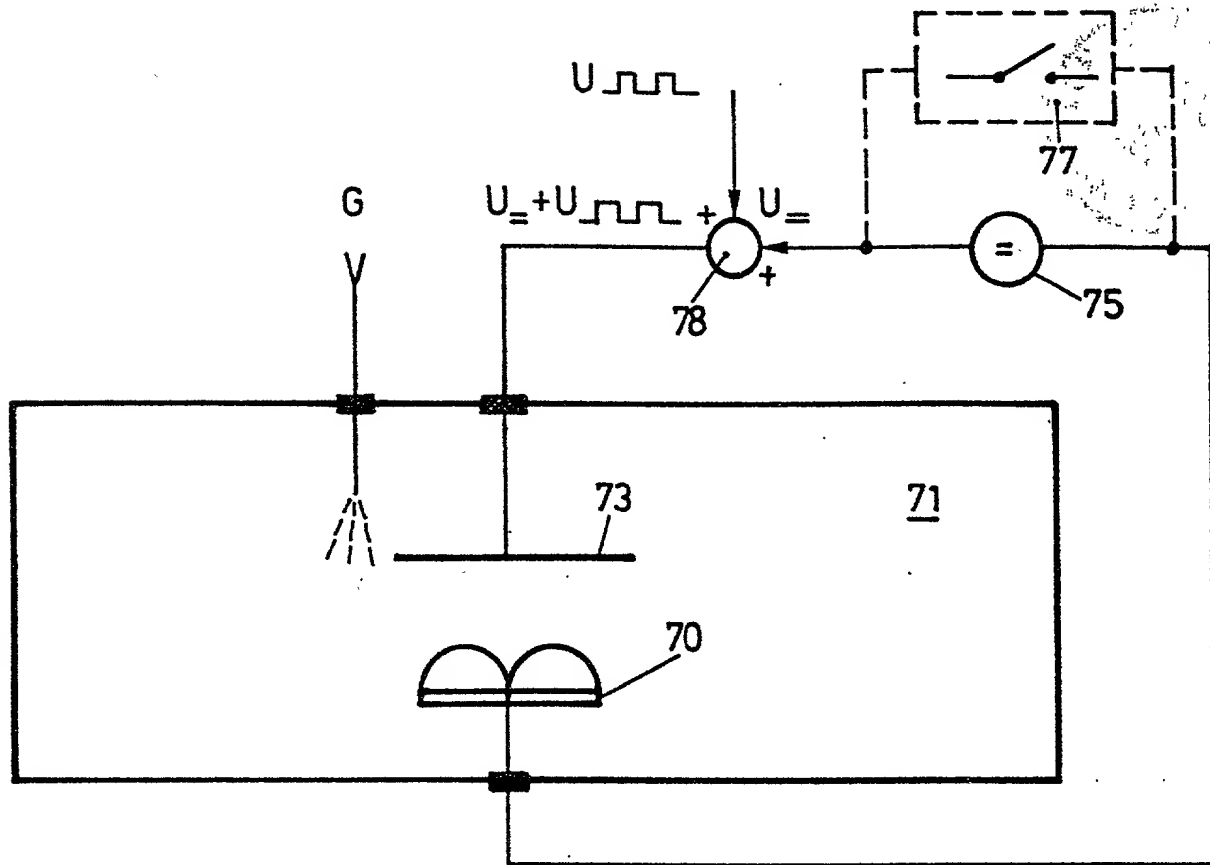


FIG. 5

English Language Declaration

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled INFORMATION CARRIER, METHOD FOR PRODUCING SAME

(check one)

[X] is attached hereto
[X] was filed on JULY 1, 1996
Application Serial No. 08/674,019 as
and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

<u>2495/95</u> (Number)	<u>Switzerland</u> (Country)	<u>01/Sept./1995</u> (Day/Month/Year Filed)	Yes [x]	No []
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(Number)	(Country)	(Day/Month/Year Filed)	Yes []	No []
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(Number)	(Country)	(Day/Month/Year Filed)	Yes []	No []
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I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

08/593,664 Jan. 29, 1996 Pending
 (Application Serial No.) (Filing Date) (Status)
 (patented, pending, abandoned)

(Application Serial No.) (Filing Date) (Status)
 (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

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08/593,664 Jan. 29, 1996 Pending